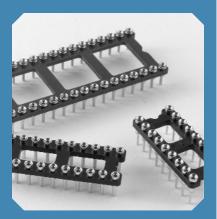
DIP Sockets



Features:

- Multiple finger contact on all sockets assures maximum reliability.
- Tapered entry for ease of insertion.
- Closed bottom sleeve for 100% anti-wicking of solder.
- To fit .100/(2.54mm) pitch.
- Easily customized to fit your application.

Specifications:

Terminals:

Brass - Copper Alloy (C36000) ASTM-B-16

Contacts:

Beryllium Copper - Copper Alloy (C17200) ASTM-B-194

Solder Preform:

Standard: 63Sn/37Pb Lead-free: 95.5Sn/4.0Ag/0.5Cu

Plating:

G - Gold over Nickel
M - Matte Tin over Nickel
T - Tin/Lead over Nickel

Gold per ASTM-B-488 Matte Tin per ASTM545-97 Tin/Lead per MIL-P-81728 Nickel per QQ-N-290



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Molded DIP Sockets Closed Frame and Open Frame

Table of Models



RDS replaces DS and HDS. RLS replaces LS and HLS.

Options



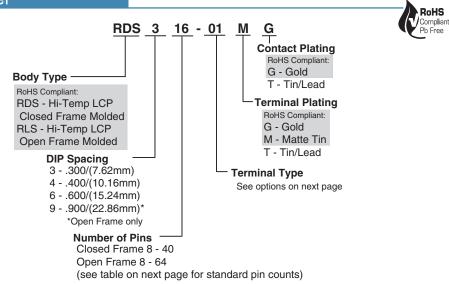
Tape Seal - add 3M to end of part number

- Removable tape seal protects plated contact in harsh environments
- Sealed socket will not allow dirt and other contaminants to enter socket chamber and become entrapped behind contact fingers
- · Spray flux without contaminating contact area

Material

Silicone Backed Polyimide Film, -74°C to 260°C (-100°F to 500°F) Intermittent to 371°C (700°F)

How To Order

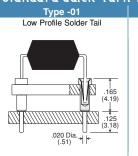


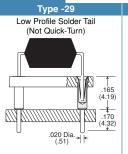
Note: Terminals plated with Matte Tin are available only with Gold plated contacts. Quick-Turn delivery is not available on products with Matte Tin plating.

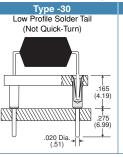
Molded DIP Sockets Closed Frame and Open Frame

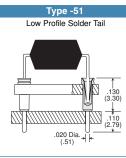
Standard Quick-Turn Terminals See Terminals section or consult factory.

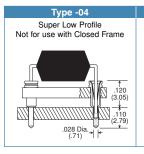
Additional standard and custom terminals available. See Terminals section or consult factory.

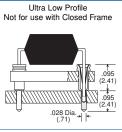




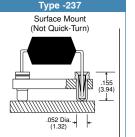








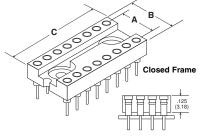
Type -49



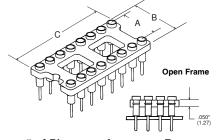
Solder Preform Terminals

Tin/Lead: Type -150	Tin/Lead: Type -151
Lead-free: Type -811	Lead-free: Type -812
Solder Preform - 125 (3.18)020 Dia. (.51)	Solder Preform

Dimensional Information



		0 0 0 0	
# of Pins	Α	В	С
8	.300	.400	.400
	(7.62)	(10.16)	(10.16)
14	.300	.400	.700
	(7.62)	(10.16)	(17.78)
16	.300	.400	.800
	(7.62)	(10.16)	(20.32)
18	.300	.400	.900
	(7.62)	(10.16)	(22.86)
20	.300	.400	1.000
	(7.62)	(10.16)	(25.40)
22	.300	.400	1.100
	(7.62)	(10.16)	(27.94)
24	.300	.400	1.200
	(7.62)	(10.16)	(30.48)
28	.300	.400	1.400
	(7.62)	(10.16)	(35.56)



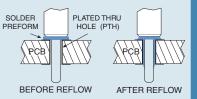
# of Pins	Α	В	С
22	.400	.500	1.100
	(10.16)	(12.70)	(27.54)
24	.400	.500	1.200
	(10.16)	(12.70)	(30.48)
24	.600	.700	1.200
	(15.24)	(17.78)	(30.48)
28	.600	.700	1.400
	(15.24)	(17.78)	(35.56)
32	.600	.700	1.600
	(15.24)	(17.78)	(40.64)
40	.600	.700	2.000
	(15.24)	(17.78)	(50.80)
48*	.600	.700	2.400
	(15.24)	(17.78)	(60.96)
64*	.900	1.000	3.200
	(22.86)	(25.40)	(81.28)

The dimensions in blue are for Open Frame only.

DIP Sockets



Intrusive Reflow Application:



- Combines the labor of socket loading and solder application into one operation.
- Eliminates the use of solder paste and screening operation.
- Eliminates solder bridges and/or solder shorts due to excess solder.
- Ensures a reliable solder joint with controlled solder volume.
- Ideal for surface mount and mixed technology applications.
- For custom solder preform terminal applications consult factory.

Available Online:

- · RoHS Qualification Test Report
- CAD Drawings



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^{*}Socket body thickness is .100/(2.54) for 48 and 64 positions.